

# CMOS CAMERA MODULES



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#### KLT-P8K-IMX323 V1.0

#### SONY IMX323 MIPI Interface Fixed Focus 2MP M12 Camera Module



| Camera Module No. | KLT-P8K-IMX323 V1.0      |  |  |
|-------------------|--------------------------|--|--|
| Image Sensor      | IMX323                   |  |  |
| EFL               | 1.05 mm                  |  |  |
| F.NO              | 2.4                      |  |  |
| Pixel             | 1985 x 1105              |  |  |
| View Angle        | 210°                     |  |  |
| Lens Type         | 1/2.9 inch               |  |  |
| Lens Dimensions   | 13.00 x 13.00 x 23.73 mm |  |  |
| Module Size       | 22.00 x 22.00 mm         |  |  |
| Module Type       | Fixed Focus              |  |  |
| Interface         | MIPI                     |  |  |



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## SONY

### **IMX323LQN**

Diagonal 6.23 mm (Type 1/2.9)

Approx. 2.19M-Effective Pixel Color CMOS Image Sensor



### Full HD Support High Sensitivity CMOS Image Sensor with a Super Small Package for Industrial Applications

Sony has commercialized the "IMX323LQN" CMOS Image Sensor that realizes a compact and thin package while maintaining low illumination performance equal to that of the existing Sony product (IMX222LQJ\*) that improved sensitivity in the near infrared region for industrial applications.

WLCSP (Wafer Level Chip Size Package) technology is used

to realize a smaller size while maintaining performance such as visibility. The package size has been reduced to 1/8 the volume of the previous product, which helps to greatly reduce the set size.

\* See the New Product Information released in August 2013

- Frame rate 30 frame/s
- On-chip 10-bit/12-bit ADC
- Pixel size: 2.8 µm-square unit pixel
- Compact and thin package using WLCSP technology 7.55mm (H) × 5.75mm (V) × 0.77mm (t)
- Improved sensitivity in the near infrared range

#### Exmor

\* Exmor is a trademark of Sony Corporation. The Exmor is a version of Sony's high performance CMOS image sensor with high-speed processing, low noise and low power dissipation by using column-parallel A/D conversion.

#### Compact and thin package

The IMX323LQN is the first Sony CMOS image sensor for industrial applications to use WLCSP (Wafer Level Chip Size Package) technology, which realized a reduced package size and thickness (7.55mm (H)  $\times$  5.75mm (V)  $\times$  0.77mm(t))

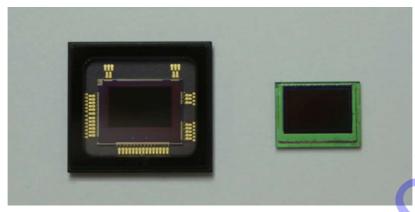
compared to the existing product IMX222LQJ (12.8mm (H)  $\times$  10.8mm (V)  $\times$  1.95mm (t)). This makes it possible to shrink the set board size, which helps to reduce the camera size (Photograph 1).

#### Improved sensitivity in the near infrared range

Improved picture quality at low illumination is strongly demanded of cameras for industrial applications. To meet this demand, Sony also applied technology to the IMX323LQN that increases sensitivity in the near infrared range as well as the

visible light range. This makes it possible to obtain clear images that enable to sufficiently discriminate subjects even under moonlit conditions. (Photograph 2).

#### <photograph 1> Comparison of existing product and IMX323LQN packages



Existing product IMX222LQJ

New product IMX323LQN

#### <Photograph 2> Image sample

Conditions: 0.1 lx, F1.4 (ADC 12 bit mode, 30 frame/s)



Existing product IMX222LQJ Gain 42 dB



New product IMX323LQN Gain 45 dB

#### <Table 1> Device Structure

| Item                       | Existing product IMX222LQJ               | New product IMX323LQN                    |  |
|----------------------------|--|--|--|
| Image size                 | Diagonal 6.4 mm (Type 1/2.8)             | Diagonal 6.23 mm (Type 1/2.9)            |  |
| Number of effective pixels | 1984 (H) x 1225 (V) Approx. 2.43M pixels | 1985 (H) × 1105 (V) Approx. 2.19M pixels |  |
| Unit cell size             | 2.8 µm (H) × 2.8 µm (V)                  |  |  |
| Supply voltage             | 2.7 V / 1.8 V / 1.2 V                    |  |  |
| Package                    | 94 pin LGA                               | 80 pin CSP BGA                           |  |
| Gain                       | 0 to 42 dB (0.3 dB Step)                 | 0 to 45 dB (0.3 dB Step)                 |  |

#### <Table 2> Image Sensor Characteristics

| Item               | 1 |      | IMX222LQJ | IMX323LQN | Remarks            |
|--------------------|---|------|-----------|-----------|--------------------|
| Sensitivity (F5.6) |   | Тур. | 510       | mV        | 1/30s accumulation |

#### <Table 3> Basic Drive Mode

| Drive mode | Recommended number of recording pixels    | ADC    | Frame rate |
|------------|---|--------|------------|
|            | 4000 (II) v 4000 (IV) Arrang 0 07M sizels | 10 bit | 30 frame/s |
| Full HD    | 1920 (H) × 1080 (V) Approx. 2.07M pixels  |        | 30 frame/s |
| HD         | 1280 (H) × 720 (V) Approx. 9.2M pixels    |        | 60 frame/s |
|            |   |        | 30 frame/s |